## 2SD1640

## Silicon NPN epitaxial planar type darlington

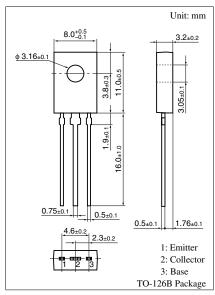
### For low-frequency output amplification

#### ■ Features

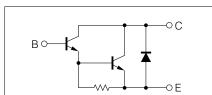
- Darlington connection
- High forward current transfer ratio h<sub>FE</sub>
- ullet Large peak collector current  $I_{CP}$
- $\bullet$  High collector to emitter voltage  $V_{\text{CEO}}$

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit
Collector to base voltage	$V_{CBO}$	120	V
Collector to emitter voltage	V <sub>CEO</sub>	100	V
Emitter to base voltage	V <sub>EBO</sub>	5	V
Peak collector current	$I_{CP}$	3	A
Collector current	$I_{C}$	2	A
Collector power dissipation	$P_{C}$	1.2	W
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C



#### **Internal Connection**



## ■ Electrical Characteristics $T_C = 25$ °C

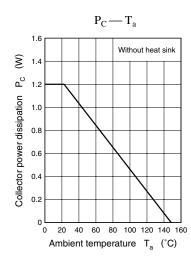
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$			0.1	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = 4 \text{ V}, I_{C} = 0$			1	μΑ
Collector to base voltage	$V_{CBO}$	$I_C = 100 \ \mu A, I_E = 0$	120			V
Collector to emitter voltage	$V_{CEO}$	$I_C = 1 \text{ mA}, I_B = 0$	100			V
Emitter to base voltage	$V_{EBO}$	$I_E = 100 \mu\text{A},  I_C = 0$	5			V
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$	4 000		40 000	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 1 A, I_B = 1 mA$			1.5	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = 1 A, I_B = 1 mA$			2	
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

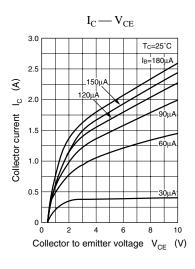
Note) \*: Rank classification

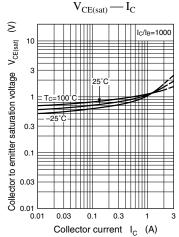
Rank	Q	R	S
$h_{FE}$	4 000 to 10 000	8 000 to 20 000	16 000 to 40 000

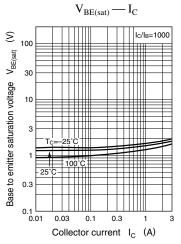
Panasonic 1

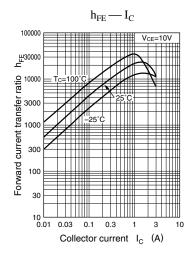
2SD1640 Power Transistors

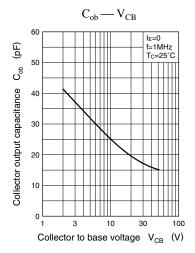


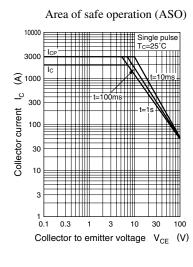


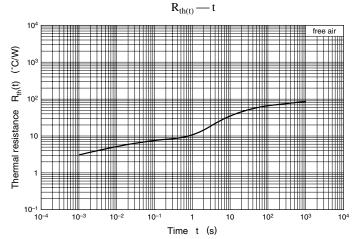












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